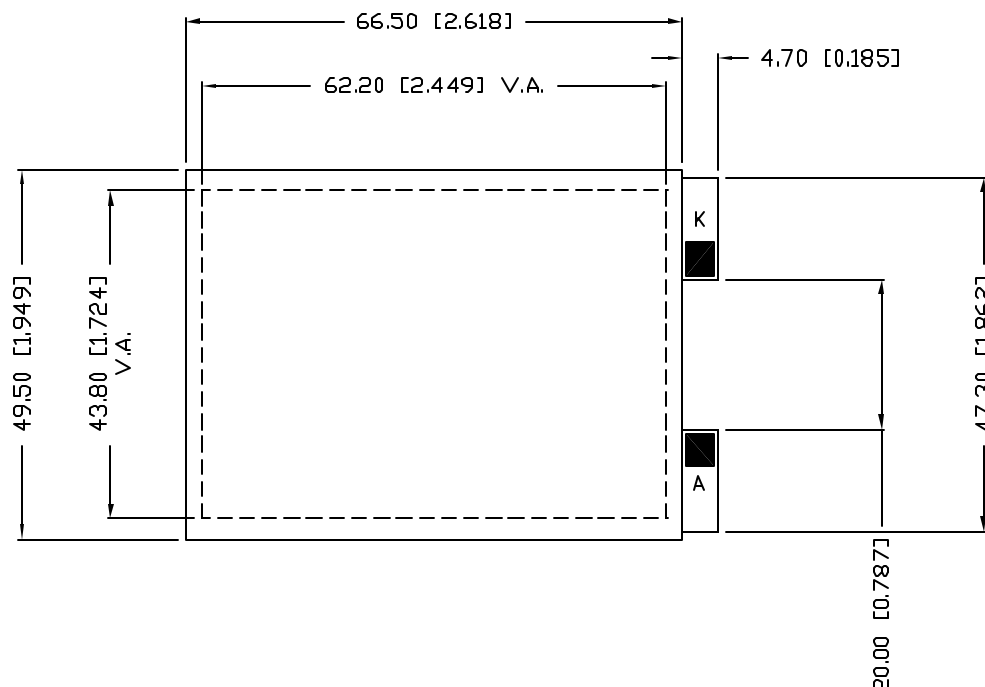
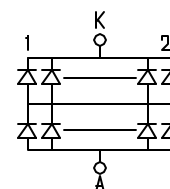


ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^\circ\text{C}$ PER MODULE					$I_f=240\text{mA}$
PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		565		nm	
FORWARD VOLTAGE		4.2	4.5	V_f	
REVERSE VOLTAGE	8			V_r	$I_r=2.4\text{mA}$
LUMINOUS INTENSITY		150		cd/m^2	$I_f=240\text{mA}$
EMITTED COLOR:	GREEN				
REFLECTOR FINISH:	WHITE				

LIMITS OF SAFE OPERATION AT 25°C PER MODULE

PARAMETER	MAX	UNITS
STEADY CURRENT	500	mA
POWER DISSIPATION	2.76	W
DERATE FROM 25°C , PER DIE	-1.2	mW/ $^\circ\text{C}$
OPERATING, STORAGE TEMP.	-40 TO +85	$^\circ\text{C}$
SOLDERING TEMP.	+260	$^\circ\text{C}$
2.0mm FROM BODY	3 SEC. MAX	



2 CHIPS IN SERIES
24 PARALLEL BRANCHES

*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: $X=\pm 1$ (± 0.039), $XX=\pm 0.5$ (± 0.020), $XXX=\pm 0.25$ (± 0.010), $XXXX=\pm 0.127$ (± 0.005). LEAD SIZE ± 0.05 (± 0.002), LEAD LENGTH ± 0.75 (± 0.030). MIN = +DECIMAL PRECISION -0.00 MAX = +0.00 -DECIMAL PRECISION

REV.

PART NUMBER

SSB-COB6244GW

CONFIDENTIAL INFORMATION

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RELIABILITY NOTE

OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.



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CHECKED BY:

APPROVED BY:

DATE: 8.2.04

PAGE: 1 OF 1

SCALE: N/A

62mm x 44mm VIEW AREA, CHIP ON BOARD LED

BACKLIGHT, 565nm GREEN, 48 CHIPS, 4.2V @ 240mA.

JD